

MiD 2022

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Company Name	Engion Co.,Ltd.	Company Logo
Address	15-15, Dongtansandan 8-gil, Hwaseong-si, Gyeonggi-do, Republic of Korea	EngiOn엔지온
President	Na Jungun	
Website	https://engion.co.kr	
E-mail	Gyohyeok.yun@engion.co.kr	
Telephone	031-378-5271	
Fax	031-378-5260	
Exhibitor Introduction	EngiOn has developed a technology that can be introduced into the actual process of predicting the electrical properties of IGZO itself. Vigth, created by Engion, can measure IV and CV characteristics directly after depositing IGZO thin film. We set up a system that can measure 3 terminals and developed a Microprobe unit that incorporated it into this technology. This allows you to predict the Vth of IGZO and it is not an indirect method, so there is no need for a separate process. The application method is also infinite and can be used in various processes. It can be introduced throughout DISPLAY production line, can be used to evaluate properties without manufacturing devices in the R&D Lab, and is expected to be useful in developing IGZO deposition systems or metal oxide semiconductors of a new composition. EngiOn is developing sixth-generation equipment with the goal in the	



	facilities that are more than 8th generation so that they can be applied to	
	mass production processes. Also, we will proceed with additional sensitivity	
	improvements for more precise measurements.	
	A new method and system to measure Metal-Oxide compound	
	semiconductor (MOx) film have been developed. The new evaluation	
	system can extract electrical characteristics of MOx-based TFT (Thin Film	
Exhibit	Transistor) such as carrier mobility and threshold voltage (V_TH) without	
Description	additional patterned electrodes. The concept of the new method is similar	
	to measuring 3-terminal-bottom gate TFT. This new method can provide	
	in-situ monitoring data of MOx film to help yield improvement of MOx-	
	based TFT applications.	
Exhibit Product	A New Evaluation System for Metal-Oxide Compound Semiconductor Film	